- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

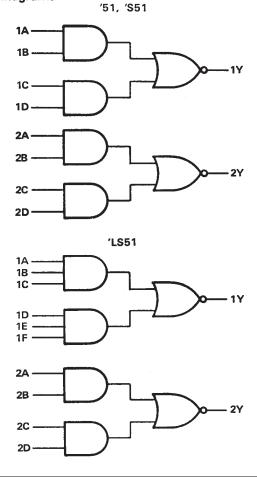
description

The '51 and 'S51 contain two independent 2-wide 2-input AND-OR-INVERT gates. They perform the Boolean function $Y = \overline{AB + CD}$.

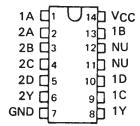
The 'LS51 contains one 2-wide 3-input and one 2-wide 2-input AND-OR-INVERT gates. They perform the Boolean functions $1Y = \overline{(1A \cdot 1B \cdot 1C) + (1D \cdot 1E \cdot 1F)}$ and $2Y = \overline{(2A \cdot 2B) + (2C \cdot 2D)}$.

The SN5451, SN54LS51, and SN54S51 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7451, SN74LS51 and SN74S51 are characterized for operation from 0°C to 70°C.

logic diagrams



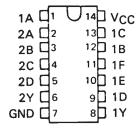
SN5451 . . . J PACKAGE SN54S51 . . . J OR W PACKAGE SN7451 . . . N PACKAGE SN74S51 . . . D OR N PACKAGE (TOP VIEW)



SN5451 . . . W PACKAGE (TOP VIEW)

ī	U 14] 1D
2	13] 1C
3	12	D 1Y
4	11	☐ GND
5	10] 2Y
6	9	2D
7	8] 2C
	3 4 5	3 12 4 11 5 10 6 9

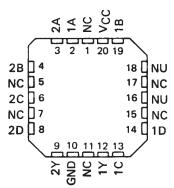
SN54LS51 . . . J OR W PACKAGE SN74LS51 . . . D OR N PACKAGE (TOP VIEW)



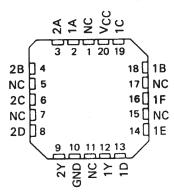
NC- No internal connection
NU - Make no external connection



SN54S51 . . . FK PACKAGE (TOP VIEW)

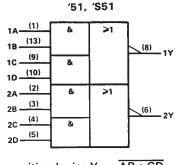


SN54LS51 . . . FK PACKAGE (TOP VIEW)

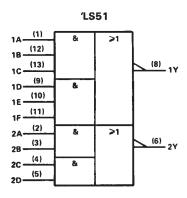


NC - No internal connection
NU - Make no external connection

logic symbols†



positive logic: $Y = \overline{AB + CD}$



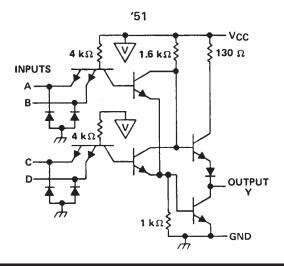
positive logic:

$$1Y = \overline{(1A \cdot 1B \cdot 1C) + (1D \cdot 1E \cdot 1F)}$$

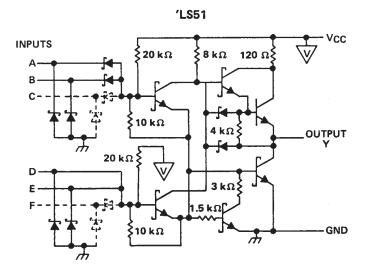
$$2Y = \overline{(2A \cdot 2B) + (2C \cdot 2D)}$$

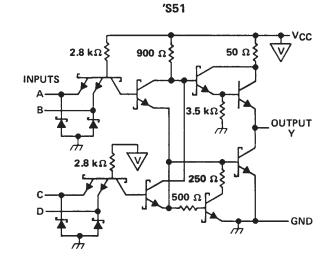
[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

schematics









absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (See Note 1): '	51, 'LS51, 'S51	7 V
Input voltage: '51, 'S51		5.5 V
′LS51		7 V
Operating free-air temperature range:	SN54'	-55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range		-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



recommended operating conditions

			SN5451			SN7451			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V _{CC} Supply	voltage	4.5	5	5.5	4.75	5	5.25	٧	
	vel input voltage	2			2			V	
	vel input voltage			0.8			0.8	V	
	vel output current			- 0.4			- 0.4	mΑ	
	vel output current			16			16	mA	
T _A Operat	ing free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST COMPLETIONS 4			SN5451			SN7451		UNIT
PARAMETER	TEST CONDITIONS †			TYP‡	MAX	MIN	TYP‡	MAX	ONLI
VIK	V _{CC} = MIN, I ₁ = -	12 mA			- 1.5			- 1.5	٧
Voн	VCC = MIN, VIL =	0.8 V, I _{OH} = - 0.4 mA	2.4	3.4		2.4	3.4		٧
VOL	V _{CC} = MIN, V _{IH} =	2 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
Ч	V _{CC} = MAX, V _I = 5.	5 V			1			1	mA
ЧН	V _{CC} = MAX, V ₁ = 2.	4 V			40			40	μΑ
I _I L	$V_{CC} = MAX$, $V_I = 0$.	4 V			– 1.6			- 1.6	mA
10S§	V _{CC} = MAX		- 20		- 55	- 18		- 55	mA
¹ ССН	$V_{CC} = MAX$, $V_I = 0$	V		4	8		4	8	mA
ICCL	V _{CC} = MAX, See No	te 2		7.4	14		7.4	14	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	A	~	B. = 400 O	C ₁ = 15 pF		13	22	ns
tPHL	Any	1	R _L = 400 Ω,	C[- 15 pr		8	15	115

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at V_{CC} = 5 V, T_A = 25° C. § Not more than one output should be shorted at a time.

recommended operating conditions

			SN54LS51			SN74LS	51	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	ONT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			٧
VIL	Low-level input voltage			0.7			8.0	V
10Н	High-level output current			-0.4			-0.4	mA
loL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

242445752	TEGT COMPLETIONS 4		S	N54LS	51	S	N74LS	51	UNIT	
PARAMETER	TEST CONDITIONS †			MIN	TYP ‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	I _I = - 18 mA				– 1. 5			– 1.5	· V
Voн	V _{CC} = MIN,	VIL = MAX,	I _{OH} = - 0.4 mA	2.5	3.4		2.7	3.4		>
V	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	V
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 8 mA					0.35	0.5	· ·
lj	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
IН	V _{CC} = MAX,	V _I = 2.7 V				20			20	μΑ
lı.	V _{CC} = MAX,	V ₁ = 0.4 V				- 0.4			- 0.4	mA
IOS§	V _{CC} = MAX			- 20		100	- 20		100	mA
Іссн	V _{CC} = MAX,	V _I = 0 V			8.0	1.6		8.0	1.6	mA
ICCL	V _{CC} = MAX,	See Note 2			1,4	2.8		1.4	2.8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	IDITIONS	MIN TYP	MAX	UNIT
tPLH		V	D210	C15 pc	12	20	ns
tPHL	Any	Y	$R_L = 2 k\Omega$,	C _L = 15 pF	12.5	20	กร

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ} \text{C}$.

[§] Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

recommended operating conditions

			SN54S51			SN74S5	1	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			8.0			0.8	V
Іон	High-level output current			1			- 1	mA
loL	Low-level output current			20			20	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN54S5	1		SN74S5	1	UNIT	
PARAMETER		TEST CONDITIONS †		MIN	TYP ‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	I _I = 18 mA				1.2			1.2	V
Voн	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = -1 mA	2.5	3.4		2.7	3.4		V
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 20 mA			0.5			0.5	V
Ц	V _{CC} = MAX,	V ₁ = 5.5 V				1			1	mA
ЧН	V _{CC} = MAX,	V _I = 2.7 V				50			50	μΑ
I _Ι Ε	V _{CC} = MAX,	V ₁ = 0.5 V				-2			-2	mA
loss	V _{CC} = MAX			- 40		- 100	40		100	mA
Іссн	V _{CC} = MAX,	V _I = 0 V			8.2	17.8		8.2	17.8	mA
ICCL	V _{CC} = MAX,	See Note 2			13.6	22		13.6	22	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN TYP	MAX	UNIT
tPLH			D - 200 C	C = 15 oF	3.5	5.5	ns
tPHL	_		R _L = 280 Ω,	C _L = 15 pF	3.5	5.5	ns
^t PLH	Any	Y	R _L = 280 Ω,	C ₁ = 50 pF	5		ns
t _{PHL}			L 200 ts,	o <u>r</u> 00 h.	5.5		ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.





30-May-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
JM38510/00502BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07401BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07401BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30401B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30401B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30401BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30401BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30401BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30401BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SN5451J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN5451J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS51J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS51J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54S51J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN7451N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7451N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7451N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7451N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS51D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51DE4	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51DE4	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51DRE4	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51DRE4	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS51N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS51NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51NSRE4	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS51NSRE4	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)		Level-2-260C-1 YEAR/ Level-1-235C-UNLIM





www.ti.com 30-May-2005

SN74S51DE ACTIVE SOIC D 14 50 Pb-Free CU NIPDAU Level-2-260C-1 YEA	Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
ROHS Level-1-235C-UNLIM	SN74S51D	ACTIVE	SOIC	D	14	50		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
RoHS Level-1-235C-UNLIM	SN74S51D	ACTIVE	SOIC	D	14	50		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S51DR	SN74S51DE4	ACTIVE	SOIC	D	14	50		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S51DR	SN74S51DE4	ACTIVE	SOIC	D	14	50		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
RoHS Level-1-235C-UNLIM SN74S51DRE4	SN74S51DR	ACTIVE	SOIC	D	14	2500		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S51DRE4	SN74S51DR	ACTIVE	SOIC	D	14	2500		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
RohS Level-1-235C-UNLIM	SN74S51DRE4	ACTIVE	SOIC	D	14	2500		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S51J OBSOLETE CDIP J 14 TBD Call TI Call TI SN74S51N ACTIVE PDIP N 14 25 Pb-Free (RoHS) CU NIPDAU Level-NC-NC-NC SN74S51N ACTIVE PDIP N 14 25 Pb-Free (RoHS) CU NIPDAU Level-NC-NC-NC SN74S51N3 OBSOLETE PDIP N 14 TBD Call TI Call TI SNJ5451J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ5451J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC <	SN74S51DRE4	ACTIVE	SOIC	D	14	2500		CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S51N ACTIVE PDIP N 14 25 Pb-Free (RoHS) CU NIPDAU Level-NC-NC-NC SN74S51N ACTIVE PDIP N 14 25 Pb-Free (RoHS) CU NIPDAU Level-NC-NC-NC SN74S51N3 OBSOLETE PDIP N 14 TBD Call TI Call TI SNJ5451N3 OBSOLETE PDIP N 14 TBD Call TI Call TI SNJ5451J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ5451J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC	SN74S51J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74S51N	SN74S51J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74S51N3 OBSOLETE PDIP N 14 TBD Call TI Call TI	SN74S51N	ACTIVE	PDIP	N	14	25		CU NIPDAU	Level-NC-NC-NC
SN74S51N3 OBSOLETE PDIP N 14 TBD Call TI Call TI SNJ5451J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ5451J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC	SN74S51N	ACTIVE	PDIP	N	14	25		CU NIPDAU	Level-NC-NC-NC
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SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54S51FK ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54S51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC	SNJ5451J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ5451W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54S51FK ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54S51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC	SNJ5451J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54S51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54S51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC	SNJ5451W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC SNJ54LS51W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC SNJ54S51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54S51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC	SNJ5451W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
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SNJ54S51FK ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC SNJ54S51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC-NC	SNJ54LS51W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S51J ACTIVE CDIP J 14 1 TBD Call TI Level-NC-NC	SNJ54LS51W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
	SNJ54S51FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S51W ACTIVE CFP W 14 1 TBD Call TI Level-NC-NC-NC	SNJ54S51J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
	SNJ54S51W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

30-May-2005

for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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